PHOTO ATTACHED: Haven Bontz; SPE Thermoforming Division logo.

Contact for SPE: Lesley Kyle, +1 914-671-9524, <u>lesley@openmindworks.com</u> Press Contact: Bob Martino +1 203-321-0787, <u>bob@martinocommunications.com</u>

For Immediate Release

SPE THERMOFORMING DIVISION AWARDS 2018 BILL BENJAMIN MEMORIAL SCHOLARSHIP TO COLLEGE STUDENT HAVEN BONTZ

CAROL STREAM, IL, U.S.A., July 9, 2018: The Society of Plastics Engineers (SPE) Thermoforming Division has awarded its Bill Benjamin Memorial Scholarship to Haven Bontz, a student at Pennsylvania College of Technology in Williamsport, PA.

Mr. Bontz has been invited to attend the 26th SPE Thermoforming Conference[®], which will be held September 24-26 at the Fort Worth Convention Center, in Fort Worth, Texas. He will be recognized during the Thermoforming Awards Dinner on Tuesday, September 25, at AT&T Stadium, home of the Dallas Cowboys.

Mr. Bontz is a junior studying for a B.S. in Plastic and Polymer Engineering Technology and expects to graduate in the Fall of 2019. Since May 2017 he has held an internship with Consolidated Container Company in Oil City, PA, where he has carried out 5S workplace organization plans and performed process validations.

"Haven has demonstrated his passion for our industry through his ongoing internship and other activities," said Matt O'Hagan, SPE Thermoforming Division Student Activities Committee Chair. "Supporting the next generation of thermoforming industry professionals is of paramount importance to the SPE Thermoforming Division."

Complete information on the Division's scholarship program and the SPE Thermoforming Conference is available at http://thermoformingdivision.com or by contacting Lesley Kyle at 1-914-671-9524 or lesley@openmindworks.com.

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THE SPE THERMOFORMING DIVISION is a technical division of the Society of Plastics Engineers, based in Bethel, CT. The Thermoforming Division's mission is to facilitate the advancement of thermoforming technologies through education, application, promotion and research. The Division hosts an annual educational conference and publishes an award-winning technical journal, *SPE Thermoforming Quarterly* ®. The Division has also funded over \$275K in equipment grants and tens of thousands of dollars in undergraduate scholarships since it was first formed. For more information, please visit http://thermoformingdivision.com.